

NCX2222

Low voltage comparator; open-drain output

Rev. 1 — 20 December 2012

Product data sheet

1. General description

The NCX2222 provides a dual, low voltage, low-power comparator with open-drain outputs.

The NCX2222 has a very low supply current of 5 μ A per comparator and is guaranteed to operate at a low voltage of 1.3 V. It is fully operational up to 5.5 V which makes it convenient for use in both 3.0 V and 5.0 V systems.

2. Features and benefits

- Wide supply voltage range from 1.3 V to 5.5 V (functional operating range)
- Rail-to-rail input/output performance
- Very low supply current of 5 μ A (typical) per comparator
- Very low-power consumption
- No phase inversion with overdriven input signals
- Internal hysteresis
- Propagation delay of 0.8 μ s (typical)
- ESD protection:
 - ◆ HBM JESD22-A114F Class 1C. Exceeds 1500 V
 - ◆ CDM JESD22-C101E exceeds 1000 V
- Multiple package options
- Specified from $-40\text{ }^{\circ}\text{C}$ to $+85\text{ }^{\circ}\text{C}$

3. Applications

- Cellular telephones
- Alarm and security systems
- Personal Digital assistants



4. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
NCX2222DP	−40 °C to +85 °C	TSSOP8	plastic thin shrink small outline package; 8 leads; body width 3 mm; lead length 0.5 mm	SOT505-2
NCX2222GU	−40 °C to +85 °C	HXSON8	plastic, thermal enhanced extremely thin small outline package; no leads; 8 terminals; body 1.35 × 1.7 × 0.5 mm	SOT972-2 ^[1]
NCX2222GT	−40 °C to +85 °C	XSON8	plastic extremely thin small outline package; no leads; 8 terminals; body 1 × 1.95 × 0.5 mm	SOT833-1
NCX2222GF	−40 °C to +85 °C	XSON8	extremely thin small outline package; no leads; 8 terminals; body 1.35 × 1 × 0.5 mm	SOT1089
NCX2222GM	−40 °C to +85 °C	XQFN8	plastic, extremely thin quad flat package; no leads; 8 terminals; body 1.6 × 1.6 × 0.5 mm	SOT902-2

[1] Lead pitch is 0.4 mm.

5. Marking

Table 2. Marking codes

Type number	Marking ^[1]
NCX2222DP	gb
NCX2222GU	gb
NCX2222GT	gb
NCX2222GF	gb
NCX2222GM	gb

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

6. Functional diagram

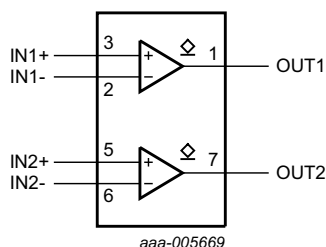


Fig 1. Logic symbol

7. Pinning information

7.1 Pinning

Transparent top view

aaa-005670

(1) This is not a supply pin, the substrate is attached to this pad using conductive die attach material. There is no electrical or mechanical requirement to solder this pad. However, if it is soldered, the solder land must remain floating or be connected to V_{EE}.

Fig 2. Pin configuration SOT972-2

Transparent top view

aaa-005671

Fig 3. Pin configuration SOT833-1 and SOT1089

Transparent top view

aaa-005672

Fig 4. Pin configuration SOT902-2

Transparent top view

aaa-005673

Fig 5. Pin configuration SOT505-2

7.2 Pin description

Table 3. Pin description

Symbol	Pin	Description
OUT1	1	comparator output 1
IN1–	2	comparator input 1 (negative)
IN1+	3	comparator input 1 (positive)
V _{EE}	4	supply voltage
IN2+	5	comparator input 2 (positive)
IN2–	6	comparator input 2 (negative)
OUT2	7	comparator output 2
V _{CC}	8	supply voltage

8. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to V_{EE}.

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-	7.0	V
V _I	input voltage	IN1–, IN1+, IN2–, IN2+ inputs	–0.5	V _{CC} + 0.5	V
V _O	output voltage		V _{EE} – 0.5	7.0	V
t _{sc(0)}	output short-circuit time	[1]	-	indefinite	s
T _{j(max)}	maximum junction temperature		-	+150	°C
T _{stg}	storage temperature		–65	+150	°C
P _{tot}	total power dissipation	T _{amb} = –40 °C to +85 °C	-	250	mW

[1] Do not exceed the maximum total power dissipation.

9. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V _{CC}	supply voltage	V _{CC} to V _{EE}				
		full spec operating range	1.6	-	5.5	V
		functional operating range	1.3	-	5.5	V
V _I	input voltage		V _{EE}	-	V _{CC}	V
V _O	output voltage		V _{EE}	-	5.5	V
T _{amb}	ambient temperature		–40	-	+85	°C

10. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. $V_{CC} = 1.6\text{ V to }5.5\text{ V}$, $V_{EE} = 0\text{ V}$; $V_{CM} = 0.5V_{CC}$ unless otherwise specified.

Symbol	Parameter	Conditions	25 °C			–40 °C to +85 °C		Unit
			Min	Typ	Max	Min	Max	
V_H	hysteresis voltage		6	9	13	-	-	mV
		$V_{CC} = 1.3\text{ V}$	-	20	-	-	-	mV
$V_{I(\text{offset})}$	offset input voltage		[1] -30	+0.5	+30	-30	+30	mV
		$V_{CC} = 1.3\text{ V}$	[1] -	3	-	-	-	mV
V_{OL}	LOW-level output voltage	$I_O = 0.5\text{ mA}$; $V_{CC} = 1.3\text{ V}$	-	0.05	-	-	-	V
		$I_O = 0.5\text{ mA}$; $V_{CC} = 1.6\text{ V}$	-	0.04	-	-	0.25	V
		$I_O = 3\text{ mA}$; $V_{CC} = 3.0\text{ V}$	-	0.14	-	-	0.3	V
		$I_O = 5\text{ mA}$; $V_{CC} = 5.5\text{ V}$	-	0.20	-	-	0.3	V
I_{OZ}	OFF-state output current	$IN- = V_{EE}$; $IN+ = V_{CC}$; $V_O = 5.5\text{ V}$	-	3	-	-	-	nA
V_{CM}	common-mode voltage	$V_{CC} = 1.3\text{ V to }5.5\text{ V}$	-	V_{EE} to V_{CC}	-	-	-	V
I_{OS}	output short-circuit current	$V_{CC} = 5.5\text{ V}$; $V_O = V_{EE}$ or V_{CC}	-	68	-	-	-	mA
CMRR	common-mode rejection ratio	$\Delta V_{CM} = V_{CC}$	-	70	-	-	-	dB
PSRR	power supply rejection ratio	$\Delta V_{CC} = 1.95\text{ V}$	45	80	-	-	-	dB
I_{IB}	input bias current		-	1.0	-	-	-	pA
I_{CC}	supply current	per comparator	-	5.0	-	-	7.0	μA

[1] Differential input switching level is guaranteed at the minimum or maximum offset voltage, minus or plus half the maximum hysteresis voltage.

11. Dynamic characteristics

Table 7. Dynamic characteristics

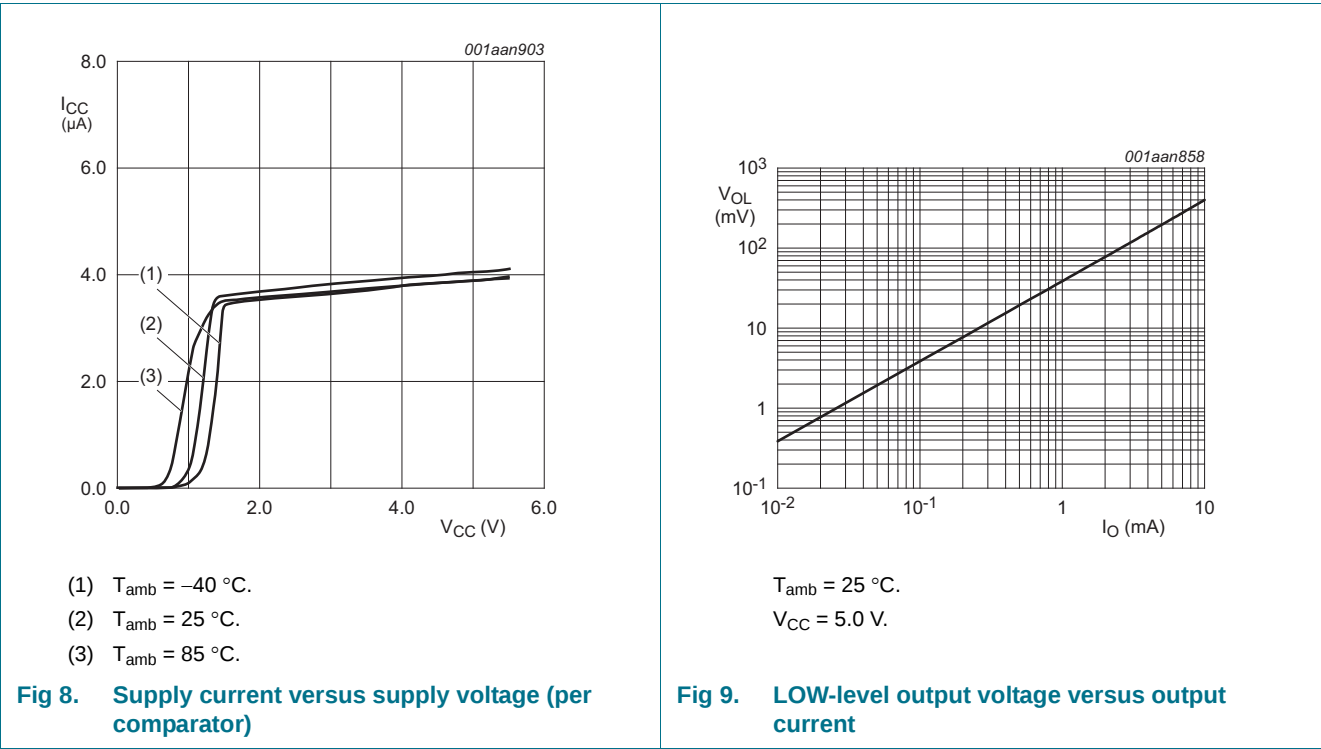
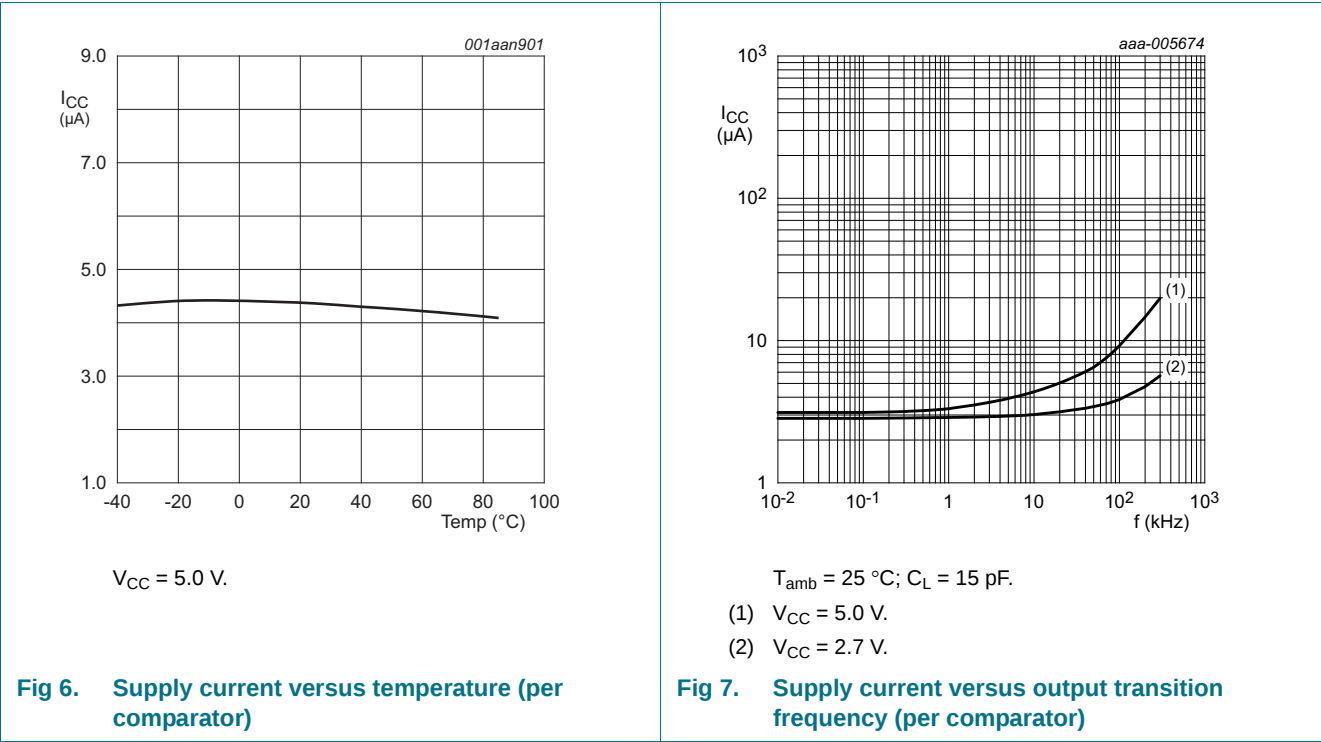
Voltages are referenced to V_{EE} ($V_{EE} = 0\text{ V}$); $V_{CC} = 1.6\text{ V to }5.5\text{ V}$; $V_{CM} = 0.5V_{CC}$ unless otherwise specified.

Symbol	Parameter	Conditions	25 °C			Unit
			Min	Typ	Max	
t_{pd}	propagation delay	20 mV overdrive; $C_L = 15\text{ pF}$	[1] -	0.8	-	μs
t_t	transition time	HIGH to LOW; $V_{CC} = 5.5\text{ V}$; $C_L = 50\text{ pF}$	[2] -	10	-	ns

[1] t_{pd} is the same as t_{PLZ} and t_{PZL} ; t_{PLZ} is the actual time that the output is disabled.

[2] Input signal: 1 kHz, square wave signal with 10 ns edge rate.

12. Graphs



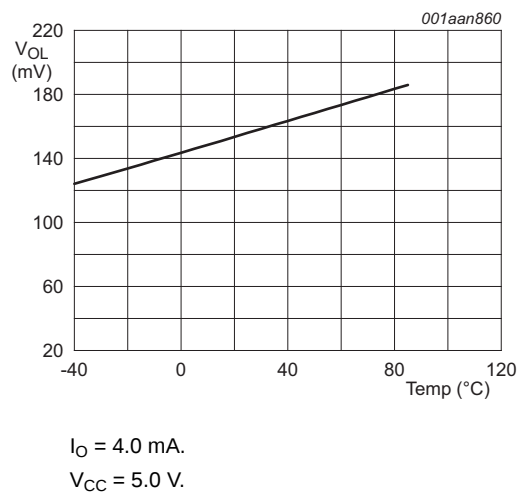


Fig 10. LOW-level output voltage versus temperature

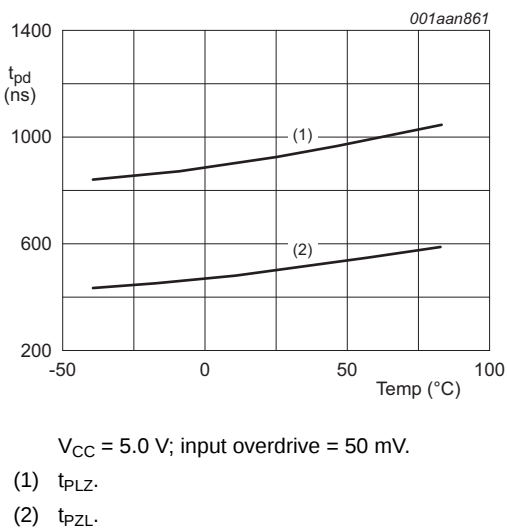


Fig 11. Propagation delay versus temperature

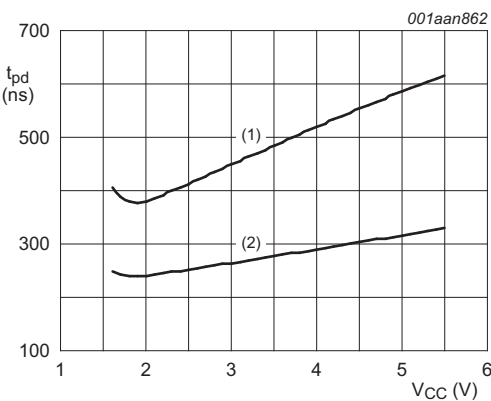


Fig 12. Propagation delay versus supply voltage.

13. Application information

13.1 Operating description

The NCX2222 is a dual, low voltage, low-power comparator with open-drain output. This device is designed for use with a pull-up resistor to define the output switching levels. This device consumes only 5 μA per comparator of supply current while achieving a typical propagation delay of 0.8 μs at a 20 mV input overdrive. [Figure 11](#) and [Figure 12](#) show propagation delay with various input overdrives. This comparator is guaranteed to operate at a low voltage of 1.3 V up to 5.5 V. The common-mode input voltage range extends 0.1 V beyond the upper and lower rail without phase inversion or other adverse effects. This device has a typical internal hysteresis of 9.0 mV which allows for greater noise immunity and clean output switching.

13.2 Output stage

The NCX2222 has an N-channel output stage that has the capability of sinking the output to V_{EE} with a load ranging up to 5.0 mA (see [Figure 13](#)).

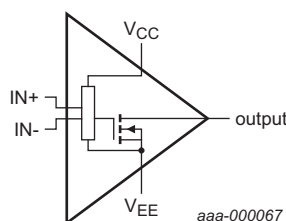


Fig 13. NCX2222 output configuration (one comparator)

13.3 Zero-crossing detector

[Figure 14](#) shows the NCX2222 configured as a zero-crossing detector.

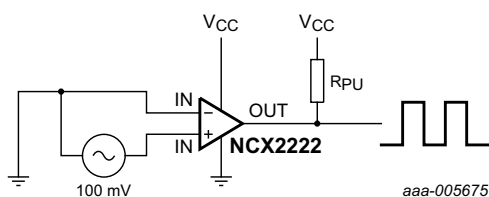
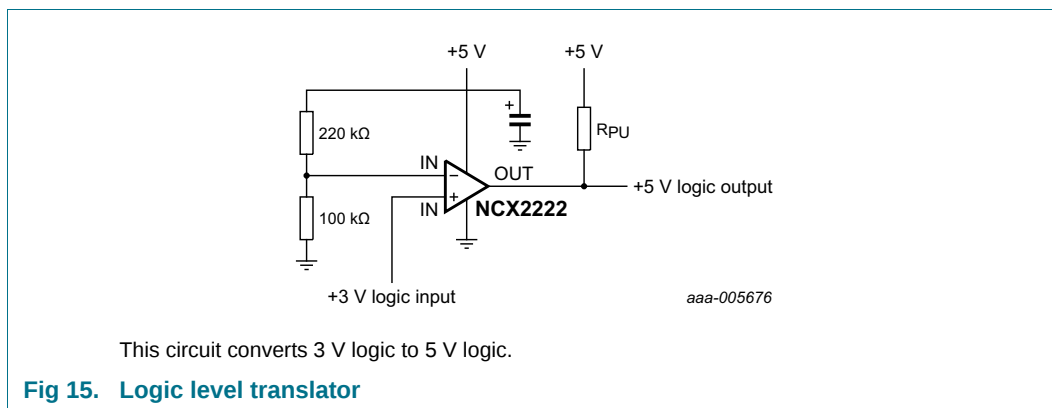


Fig 14. Zero-crossing detector

13.4 Logic level translator

Figure 15 shows the NCX2222 configured as a logic level translator.



14. Package outline

TSSOP8: plastic thin shrink small outline package; 8 leads; body width 3 mm; lead length 0.5 mm SOT505-2

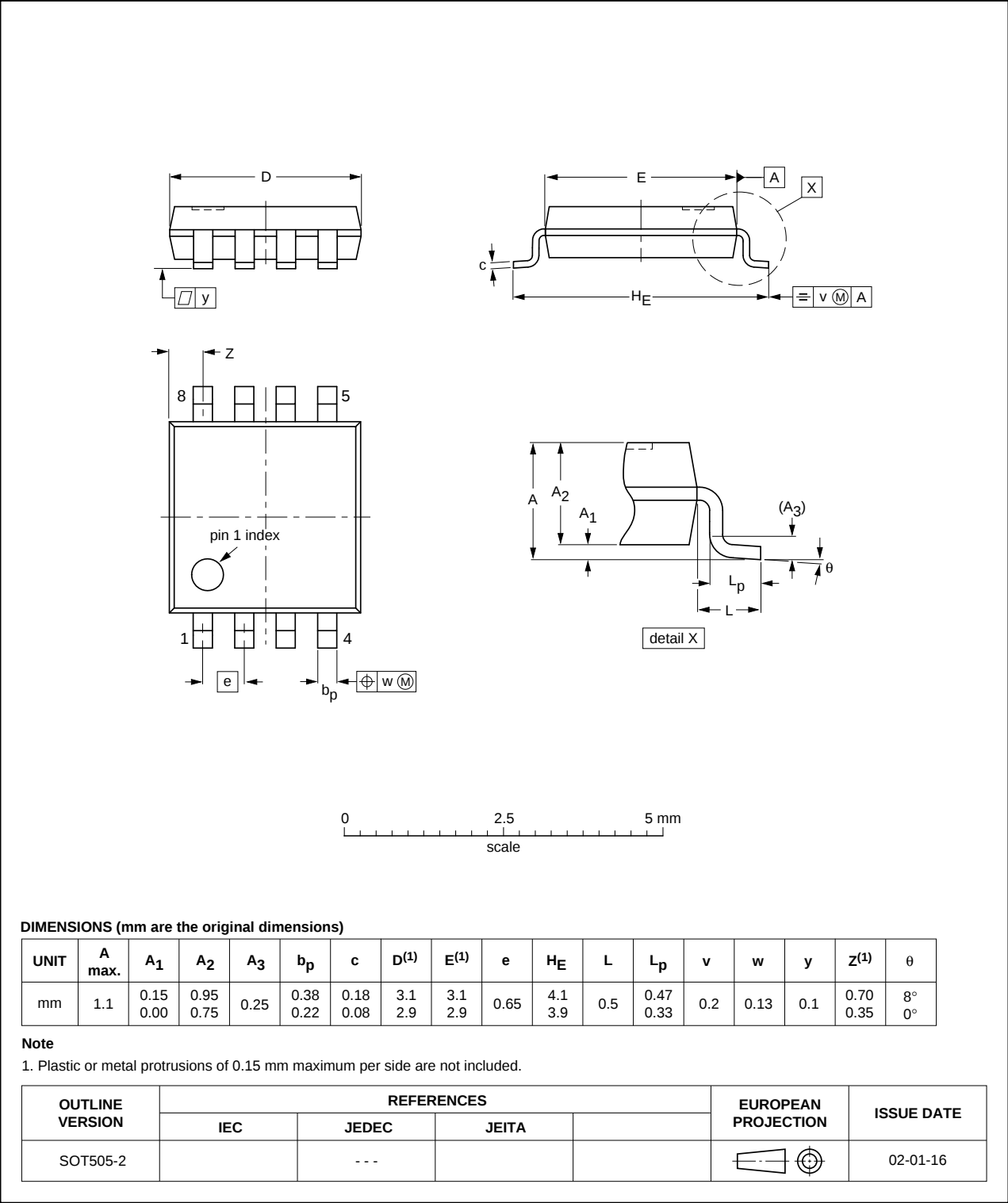


Fig 16. Package outline SOT505-2 (TSSOP8)

HXSON8: plastic, thermal enhanced extremely thin small outline package; no leads;
8 terminals; body 1.35 x 1.7 x 0.5 mm

SOT972-2

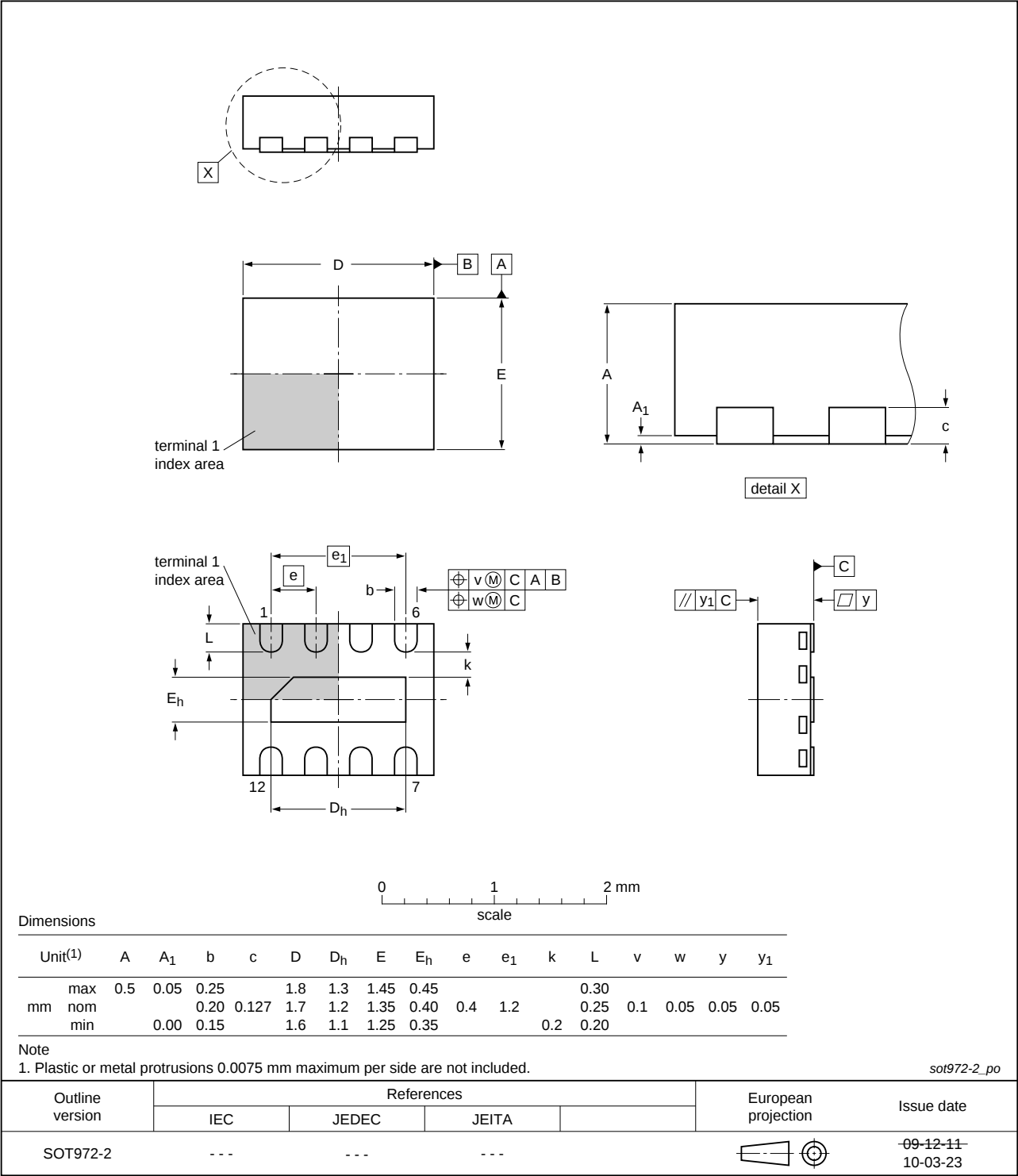


Fig 17. Package outline SOT972-2 (HXSON8)

XSON8: plastic extremely thin small outline package; no leads; 8 terminals; body 1 x 1.95 x 0.5 mm

SOT833-1

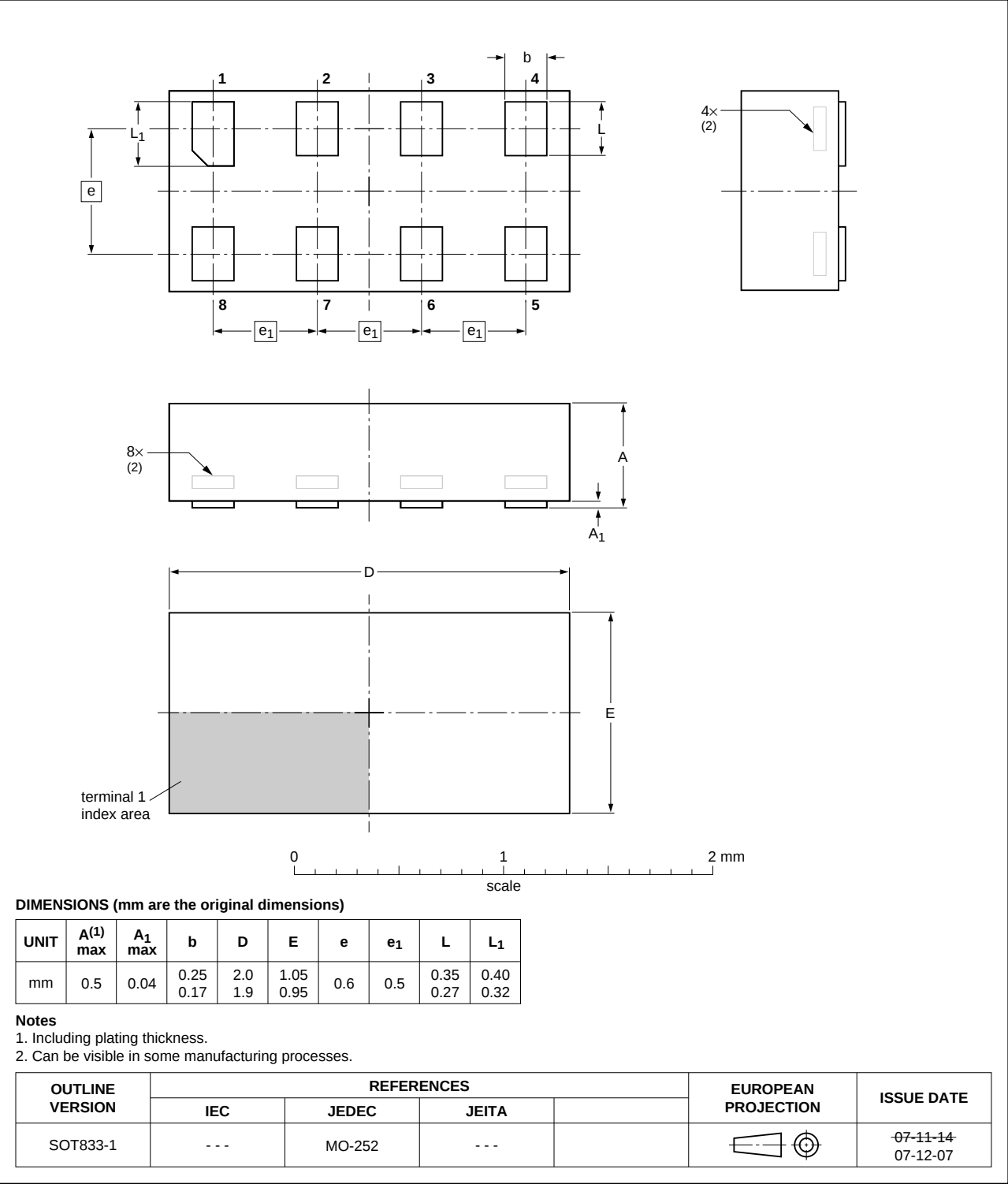


Fig 18. Package outline SOT833-1 (XSON8)

XSON8: extremely thin small outline package; no leads;
8 terminals; body 1.35 x 1 x 0.5 mm

SOT1089

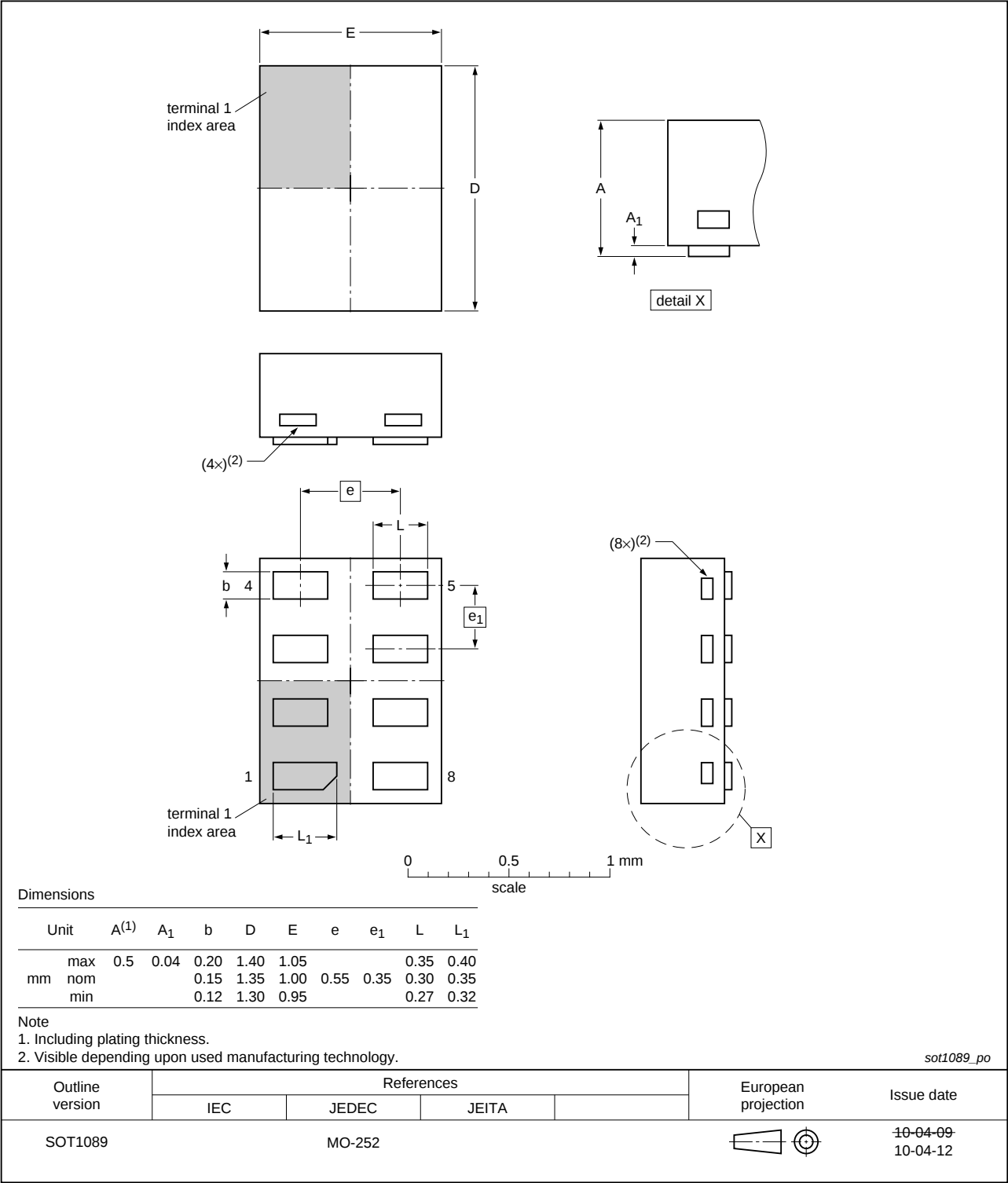


Fig 19. Package outline SOT1089 (XSON8)

XQFN8: plastic, extremely thin quad flat package; no leads;
8 terminals; body 1.6 x 1.6 x 0.5 mm

SOT902-2

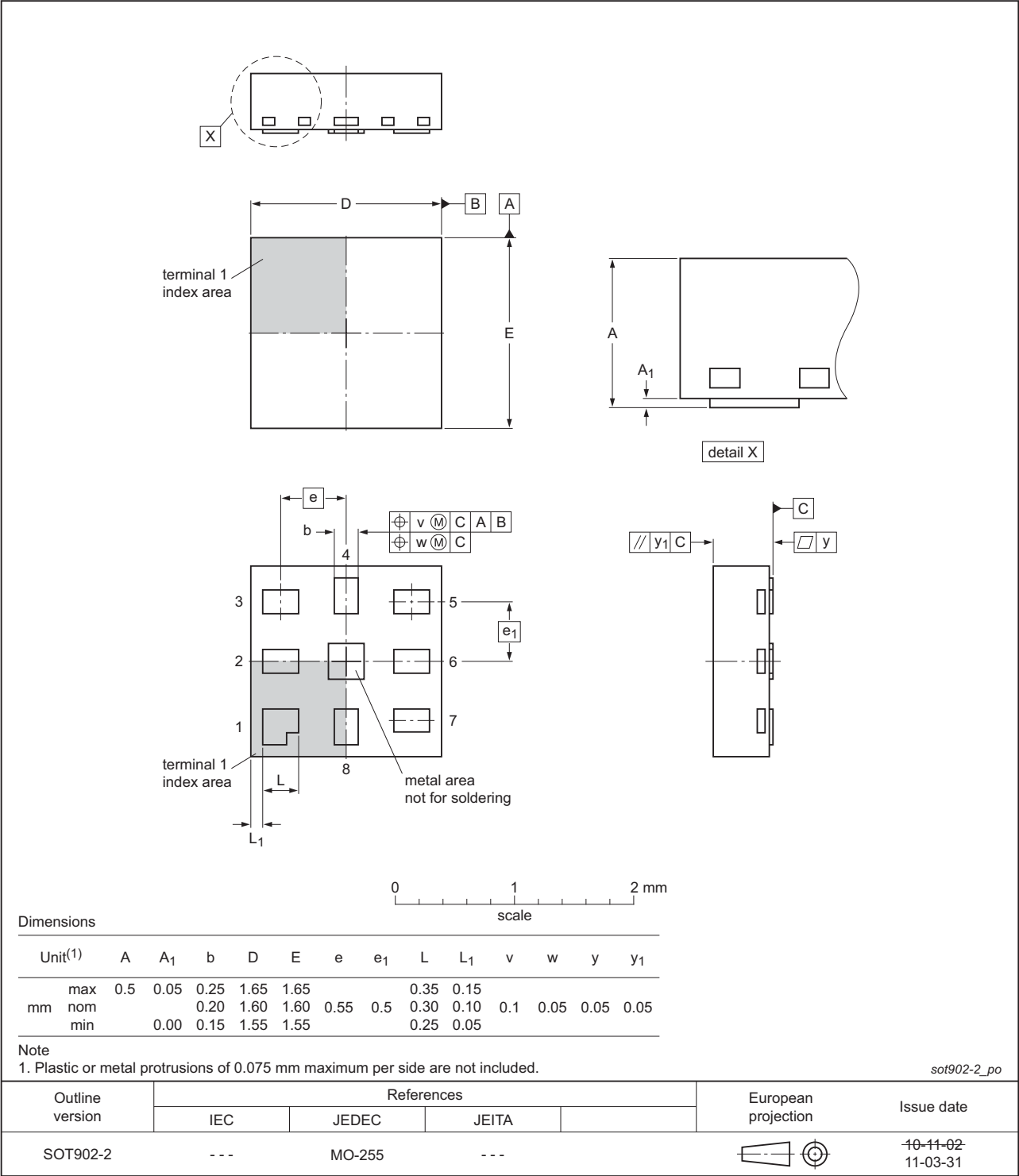


Fig 20. Package outline SOT902-2 (XQFN8)

15. Abbreviations

Table 8. Abbreviations

Acronym	Description
CDM	Charged Device Model
ESD	ElectroStatic Discharge
HBM	Human Body Model

16. Revision history

Table 9. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
NCX2222 v.1	20121220	Product data sheet	-	-

17. Legal information

17.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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[2] The term 'short data sheet' is explained in section "Definitions".

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